

Multi output SAW Oscillator (MOSO) OUTPUT: HCSL





Product Number X1M000431xxxx00

MG7050HAN

Feature

•Ultra Low jitter : 0.3 ps Max.

or 4 outputs and it is able to reduce fan-out buffers
 Frequency range : 100 MHz to 200 MHz
 Supply voltage : 2.5 V / 3.3 V
 External dimensions : 7.0 × 5.0 × 1.6 mm
 Output : HCSL (2 or 4 outputs)

Output impedance select by ZSEL

Application

GbE, Fiber Channel, SAS, PCI express

E MG7050 100 000 H 0 40738KA



Specifications (characteristics)

Item	Symbol	Specifications		Conditions / Remarks	
Output froguency range	fo	100 MHz to 200 MHz		Please contact us about available frequencies.	
Output frequency range		100 MHz, 125 MHz, 156.25 MHz, 200 MHz		Standard frequency	
Supply voltage	V _{cc}	D: 2.5 V ± 0.125 V	C: 3.3 V ± 0.33 V	V _{cc} , V _{cc} 1 and V _{cc} 2 need same voltage	
Storage temperature	T_stg	-55 °C to +125 °C		Store as bare product after packing	
Operating temperature	T_use	A: 0 °C to +70 °C, B: -20 °C to +70 °C D: -5 °C to +85 °C			
Frequency tolerance *1	f_tol	J: ±50 × 10 ⁻⁸ , L: ±100 × 10 ⁻⁸			
Current consumption	Icc	55 mA Typ., 84 mA Max.	60 mA Typ., 90 mA Max.	2-outputs	OE=V _{cc} , with L_HCSL
Current consumption	Icc	95 mA Typ., 128 mA Max.	100 mA Typ., 136 mA Max.	4-outputs	
Disable current	I dis	11 mA Typ., 23 mA Max.	12 mA Typ., 25 mA Max.	2-outputs	OE=GND
Disable Culterit	I_uis	15 mA Typ., 28 mA Max.	16 mA Typ., 30 mA Max.	4-outputs	
Symmetry	SYM	45 % t	o 55 %	At outputs crossing point	
Output voltage	V _{OH}	0.66 V to 0.85 V		DC characteristics	
Output voltage	V _{OL}	-0.15 V to 0.15 V			
Output load condition	L_HCSL	50 Ω or 42.2 Ω , with C _L =2 pF, Rs=33 Ω or 27 Ω			
Input voltage	V _{IH}	70 % V _{cc} Min.		OE and ZSEL terminals	
input voltage	V _{IL}	30 % V _{cc} Max.			
Rise / Fall skew rate	Rr / Rf	1 V/ns t	o 4 V/ns	Between -0.15 V and 0.15 V of differential output.	
Start-up time	t_str	5 ms Typ.,	10 ms Max.	Time at minimum supply voltage to be 0 s	
		0.19 ps Typ.	0.16 ps Typ.	fo=100 MHz	Offset frequency: 12 kHz to 20 MHz
	t _{PJ}	0.18 ps Typ.	0.15 ps Typ.	fo=125 MHz	
Phase Jitter		0.16 ps Typ.	0.13 ps Typ.	fo=156.25 MHz	
		0.14 ps Typ.	0.12 ps Typ.	fo=200 MHz	
		0.3 ps Max.			
Skew	t_skew	20 ps Typ., 50 ps Max.		ZSEL=H	
Aging	f_age	N: ±10 × 10 ⁻⁶ / year Max.		First year	+25 C, V _{cc} =2.5 V, 3.3 V
/ 191119		A: Included in Frequency tolerance *2		10 years	123 C, V _{CC} -2.3 V, 3.3 V

^{*1} Frequency tolerance includes initial frequency tolerance, temperature variation, supply voltage change and reflow drift.

Product Name (Standard form)

MG7050 H AN 156.250000MHz 4 A C J A N 3 3 4 5 6 7 8 9

(789:JDA, JBA are not available)

- ①Model
- 2Output (H: HCSL)
- ③Frequency
- Number of outputs (2: 2-outputs, 4: 4-outputs)
- ⑤"A": Fixed
- **6**Supply voltage
- ®Frequency tolerance
- ®Operating temperature

6 S	supply voltage
С	3.3 V Typ.
D	2.5 V Tvn

⑦ F	⑦Frequency tolerance		
J	±50 × 10 ⁻⁶		
L	±100 × 10 ⁻⁶		

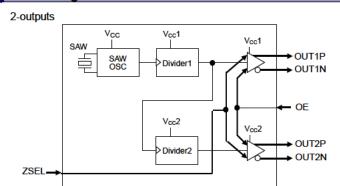
®Operating temp.		
Α	0 °C to +70 °C	
В	-20 °C to +70 °C	
D	-5 °C to +85 °C	

Α	Frequency tolerance include aging		
N	Frequency tolerance exclude aging		

^{*2 &}quot;A" is not acceptable when Frequency tolerance is "J" and Operating temperature is "B" or "D".

► OUT4N

Crystal oscillator Block diagram



4-outputs V_{cc}1 V_{cc}1 SAW ►OUT1P SAW Divider1 ► OUT1N OUT2P ► OUT2N OE ► OUT3P Divider2 ► OUT3N OUT4P

ZSEL function

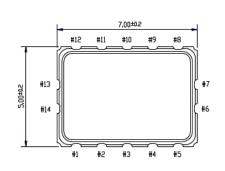
		Output line Differential Zo	HCSL load L_HCSL	Shunt resistor Rs
ZSEL	Н	100 Ω	50 Ω	33 Ω
	L	85 Ω	42.2 Ω	27 Ω

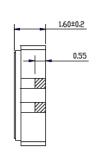
External dimensions

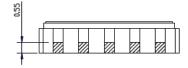
(Unit :mm)

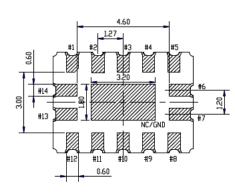
ZSEL.

Footprint (Recommended) (Unit :mm)



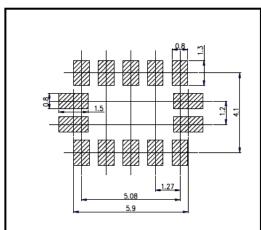






OE pin = "H" : Specified frequency output. OE pin = "L" : Output is high impedance #14 is connected to the cover.

Pin	Connection		
PIN	2-outputs	4-outputs	
1	V _{cc} 1		
2	GND OUT1P		
3	OUT1P	OUT1N	
4	OUT1N	OUT2P	
5	GND	OUT2N	
6	ZSEL		
7	OE		
8	GND OUT3N		
9	OUT2N OUT3P		
10	OUT2P	OUT4N	
11	GND	OUT4P	
12	V _{cc} 2		
13	V _{cc}		
14	GND		



To maintain stable operation, provide a 0 01 μF to 0.1 μF by-pass capacitor at a loca ion as near as possible to the power source terminal of the crystal product (between Vcc, Vcc1, Vcc2 - GND).

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

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IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

Explanation of the mark that are using it for the catalog



►Pb free.



► Complies with EU RoHS directive.

*About the products without the Pb-free mark.

Contains Pb in products exempted by EU RoHS directive.

(Contains Pb in sealing glass, high melting temperature type solder or other.)



▶ Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.



▶ Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc.).

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